

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TAE MIN KANG	07/01/2010
YOU KYUNG HWANG	07/01/2010
JAE-HYUN SON	07/01/2010
DAE WOONG LEE	07/01/2010
CHUL KEUN YOON	07/01/2010
BYOUNG DO LEE	07/01/2010
YU HWAN KIM	07/01/2010
RECEIVING PARTY DATA	
Name:	HYNIX SEMICONDUCTOR INC.
Street Address:	SAN 136-1, AMI-RI, BUBAL-EUP, ICHEON-SI
City:	GYEONGGI-DO
State/Country:	REPUBLIC OF KOREA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12835053
CORRESPONDENCE DATA	
Fax Number:	(312)427-6663
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Phone:	3124271300
Email:	nicholas.kubacki@ladas.net
Correspondent Name:	RICHARD J. STREIT
Address Line 1:	LADAS & PARRY, 224 SOUTH MICHIGAN AVE.
Address Line 4:	CHICAGO, ILLINOIS 60604
ATTORNEY DOCKET NUMBER:	CU-8398 BWH/HYNIX/NK
NAME OF SUBMITTER:	Brian W. Hameder

CH \$40.00 12835053

Total Attachments: 3

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UNITED STATES OF AMERICA
ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

ASSIGNOR:

Name : Tae Min KANG

Address : 181-32, Jeongneung 1-dong, Seongbuk-gu, Seoul, Korea

Name: You Kyung HWANG

Address: 101-304, Sungliwoorimi Apt., 637 Bunji, Donam-dong, Seongbuk-gu, Seoul, Korea

Name : Jae-hyun Son

Address : Ssangyong202-901, Konjiam, Silchon-eup, Gwangju-si, Gyeonggi-do, Korea

Name : Dae Woong LEE

Address : 2001, Baekhyeonmaeulsangnoklottecastle Apt., Jung-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Korea

Name : Chul Keun YOON

Address: 509-804, Sindongadaewoon Apt., Gwonseon-dong, Gwonseon-gu, Suwon-si, Gyeonggi-do, Korea

Name : Byoung Do LEE

Address : 1406-802, SeoksuLGvillage Apt., Seoksu 2-dong, Manan-gu, Anyang-si, Gyeonggi-do, Korea

Name : Yu Hwan KIM

Address : #5, 724-4 Bunji, Simgokbon-dong, Sosa-gu, Bucheon-si, Gyeonggi-do, Korea

(INVENTOR NAME AND ADDRESS)

hereby sells, assigns and transfers to

ASSIGNEE:

Name : Hynix Semiconductor Inc.

Address : San 136-1, Ami-ri, Bubal-eup, Icheon-si, Gyeonggi-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the invention entitled:

STACK SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING
THE SAME



(TITLE)

and which is found in (check one applicable item below)

- U.S. patent application executed on even date herewith
 U.S. Application Serial No. _____ filed on _____

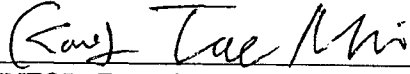
and, in and to all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, substitute, reissue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

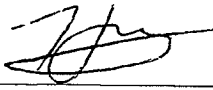
ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

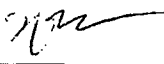
July 1, 2010
Date


INVENTOR: Tae Min KANG


July 1, 2010
Date


INVENTOR: You Kyung HWANG


July 1, 2010
Date


INVENTOR: Jae-hyun Son

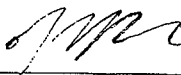
July 1, 2010
Date


INVENTOR: Dae Woong LEE

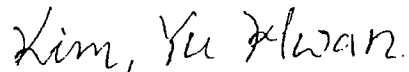
July 1, 2010
Date


INVENTOR: Chul Keun YOON

July 1, 2010
Date


INVENTOR: Byoung Do LEE

July 1, 2010


INVENTOR: Kim, Yu Hwan



0699P/1 Date

INVENTOR: Yu Hwan KIM



RECORDED: 07/13/2010

PATENT
B34003/177 : 79 10 : 12072010-06-22 09:13
REEL: 024673 FRAME: 0742